

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Hui et al.	Docket No.: TI-27874
Serial No: TBD	Examiner: TBD
Filed: 10/18/01	Art Unit: TBD
For: DIE PAD FOR INTEGRATED CIRCUITS	

PRELIMINARY AMENDMENT

October 18, 2001

Assistant Commissioner for Patents

Washington, DC 20231

Dear Sir:

Please amend the above referenced application as follows:

In the Specification:

Page 1, before line 1, insert --This application claims priority under 35 USC § 119(e)(1) of provisional application numbers **60/254,567** filed **12/11/00**.--

[illegible]

If the Examiner has any questions or other correspondence regarding this application, Applicant requests that the Examiner contact Applicant's attorney at the below listed telephone number and address.



Jacqueline J. Garner
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Reg. No. 36,144